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DATA SHEET www.onsemi.com

Digital Transistors (BRT) R1 = 4.7 k Ω , **R2 =** ∞ **k** Ω

NPN Transistors with Monolithic Bias Resistor Network

MUN2216, MMUN2216L, MUN5216, DTC143TE, DTC143TM3, NSBC143TF3

This series of digital transistors is designed to replace a single device and its external resistor bias network. The Bias Resistor Transistor (BRT) contains a single transistor with a monolithic bias network consisting of two resistors; a series base resistor and a base–emitter resistor. The BRT eliminates these individual components by integrating them into a single device. The use of a BRT can reduce both system cost and board space.

Features

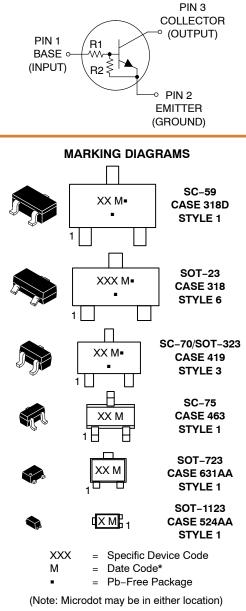
- Simplifies Circuit Design
- Reduces Board Space
- Reduces Component Count

MAXIMUM RATINGS ($T_A = 25^{\circ}C$)

- S and NSV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

Rating	Symbol	Max	Unit		
Collector-Base Voltage	V _{CBO}	50	Vdc		
Collector-Emitter Voltage	V _{CEO}	50	Vdc		
Collector Current – Continuous	Ι _C	100	mAdc		
Input Forward Voltage	V _{IN(fwd)}	30	Vdc		
Input Reverse Voltage	V _{IN(rev)}	6	Vdc		

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.



PIN CONNECTIONS

*Date Code orientation may vary depending upon manufacturing location.

ORDERING INFORMATION

See detailed ordering, marking, and shipping information on page 2 of this data sheet.

NOTE: Some of the devices on this data sheet have been **DISCONTINUED**. Please refer to the table on page 2.

MUN2216, MMUN2216L, MUN5216, DTC143TE, DTC143TM3, NSBC143TF3

Table 1. ORDERING INFORMATION

Device	Part Marking	Package	Shipping [†]
MUN2216T1G, SMUN2216T1G	8F	SC–59 (Pb–Free)	3000 / Tape & Reel
MMUN2216LT1G, SMMUN2216LT1G	A8F	SOT-23 (Pb-Free)	3000 / Tape & Reel
SMMUN2216LT3G	A8F	SOT-23 (Pb-Free)	10000 / Tape & Reel
MUN5216T1G, NSVMUN5216T1G	8F	SC-70/SOT-323 (Pb-Free)	3000 / Tape & Reel
DTC143TET1G	8F	SC–75 (Pb–Free)	3000 / Tape & Reel
DTC143TM3T5G	8F	SOT-723 (Pb-Free)	8000 / Tape & Reel

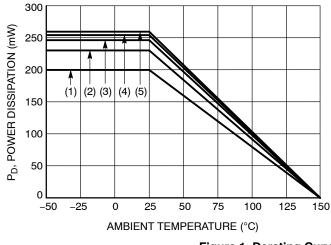
DISCONTINUED (Note 1)

			,
NSBC143TF3T5G	F (180°)	SOT-1123	8000 / Tape & Reel
		(Pb-Free)	

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

* $(xx^{\circ}) =$ Degree rotation in the clockwise direction.

1. **DISCONTINUED:** This device is not recommended for new design. Please contact your **onsemi** representative for information. The most current information on this device may be available on <u>www.onsemi.com</u>.



(1) SC-75 and SC-70/SOT323; Minimum Pad
(2) SC-59; Minimum Pad
(3) SOT-23; Minimum Pad
(4) SOT-1123; 100 mm², 1 oz. copper trace

(5) SOT-723; Minimum Pad

Figure 1. Derating Curve

Table 2. THERMAL CHARACTERISTICS

	Characteristic	Symbol	Max	Unit
THERMAL CHARACTER	STICS (SC-59) (MUN2216)			
Total Device Dissipation		PD		
$T_A = 25^{\circ}C$	(Note 2)	_	230	mW
	(Note 3)		338	
Derate above 25°C	(Note 2)		1.8	mW/°C
	(Note 3)		2.7	
Thermal Resistance,	(Note 2)	$R_{ heta JA}$	540	°C/W
Junction to Ambient	(Note 3)		370	
Thermal Resistance,	(Note 2)	R _{θJL}	264	°C/W
Junction to Lead	(Note 3)	002	287	
Junction and Storage Tem	perature Range	T _J , T _{stg}	-55 to +150	°C
THERMAL CHARACTER	STICS (SOT-23) (MMUN2216L)			
Total Device Dissipation		PD		
$T_A = 25^{\circ}C$	(Note 2)		246	mW
	Note 3)		400	
Derate above 25°C	Note 2)		2.0	mW/°C
	(Note 3)		3.2	
Thermal Resistance,	(Note 1)	R _{0JA}	508	°C/W
Junction to Ambient	(Note 3)		311	
Thermal Resistance,	(Note 2)	R _{θJL}	174	°C/W
Junction to Lead	(Note 3)		208	
Junction and Storage Tem	perature Range	T _J , T _{stg}	–55 to +150	°C
THERMAL CHARACTER	STICS (SC-70/SOT-323) (MUN5216)			
Total Device Dissipation		PD		
T _A = 25°C	(Note 2)	D	202	mW
	(Note 3)		310	
Derate above 25°C	(Note 2)		1.6	mW/°C
	(Note 3)		2.5	
Thermal Resistance,	(Note 2)	R _{0JA}	618	°C/W
Junction to Ambient	(Note 3)	0071	403	
Thermal Resistance,	(Note 2)	R _{θJL}	280	°C/W
Junction to Lead	(Note 3)	, ADE	332	0/11
Junction and Storage Tem	perature Range	T _J , T _{stq}	–55 to +150	°C
	STICS (SC-75) (DTC143TE)	0. 0.9		
Total Device Dissipation		PD		
$T_A = 25^{\circ}C$	(Note 2)		200	mW
	(Note 3)		300	
Derate above 25°C	(Note 2)		1.6	mW/°C
	(Note 3)		2.4	
Thermal Resistance,	(Note 2)	$R_{\theta JA}$	600	°C/W
Junction to Ambient	(Note 3)		400	
Junction and Storage Tem	perature Range	T _J , T _{stg}	–55 to +150	°C
HERMAL CHARACTER	STICS (SOT-723) (DTC143TM3)			
Total Device Dissipation		PD		
T _A = 25°C	(Note 2)		260	mW
	(Note 3)		600	
Derate above 25°C	(Note 2)		2.0	mW/°C
	(Note 3)		4.8	
Thermal Resistance,	(Note 2)	R _{θJA}	480	°C/W
Junction to Ambient	(Note 3)	· · · · · · · · · · · · · · · · · · ·	205	,
Junction and Storage Tem	perature Bange	TJ, T _{stg}	-55 to +150	°C
etereige form		· J, · sig		-

Table 2. THERMAL CHARACTERISTICS

	Characteristic	Symbol	Мах	Unit		
THERMAL CHARACTERISTICS (SOT-1123) (NSBC143TF3)						
Total Device Dissipation $T_A = 25^{\circ}C$ Derate above 25°C	(Note 4) (Note 5) (Note 4) (Note 5)	PD	254 297 2.0 2.4	mW mW/°C		
Thermal Resistance, Junction to Ambient	(Note 4) (Note 5)	$R_{ hetaJA}$	493 421	°C/W		
Thermal Resistance, Junction to Lead	(Note 4)	$R_{ hetaJL}$	193	°C/W		
Junction and Storage Tem	perature Range	T _J , T _{stg}	-55 to +150	°C		

2. FR-4 @ Minimum Pad.

Output Voltage (on)

3. FR-4 @ 1.0 x 1.0 Inch Pad.

FR-4 @ 100 mm², 1 oz. copper traces, still air.
 FR-4 @ 500 mm², 1 oz. copper traces, still air.

Table 3. ELECTRICAL CHARACTERISTICS ($T_A = 25^{\circ}C$, unless otherwise noted)

Characteristic	Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTICS			-		
Collector-Base Cutoff Current $(V_{CB} = 50 \text{ V}, I_E = 0)$	I _{CBO}	_	-	100	nAdc
Collector–Emitter Cutoff Current $(V_{CE} = 50 \text{ V}, I_B = 0)$	I _{CEO}	_	-	500	nAdc
Emitter-Base Cutoff Current ($V_{EB} = 6.0 \text{ V}, I_C = 0$)	I _{EBO}	_	-	1.9	mAdc
Collector-Base Breakdown Voltage $(I_C = 10 \ \mu A, I_E = 0)$	V _{(BR)CBO}	50	-	-	Vdc
Collector–Emitter Breakdown Voltage (Note 6) $(I_{C} = 2.0 \text{ mA}, I_{B} = 0)$	V _{(BR)CEO}	50	-	-	Vdc
ON CHARACTERISTICS					
DC Current Gain (Note 6) ($I_C = 5.0 \text{ mA}, V_{CE} = 10 \text{ V}$)	h _{FE}	160	350	_	
Collector–Emitter Saturation Voltage (Note 6) ($I_C = 10 \text{ mA}, I_B = 1.0 \text{ mA}$)	V _{CE(sat)}	_	-	0.25	Vdc
Input Voltage (off) $(V_{CE} = 5.0 \text{ V}, I_C = 100 \mu\text{A})$	V _{i(off)}	_	0.6	0.5	Vdc
Input Voltage (on) $(V_{CE} = 0.3 \text{ V}, I_C = 10 \text{ mA})$	V _{i(on)}	1.3	0.9	_	Vdc
		1	1	1	

 $(V_{CC} = 5.0 \text{ V}, V_B = 2.5 \text{ V}, \text{R}_L = 1.0 \text{ k}\Omega)$ Output Voltage (off) $(V_{CC} = 5.0 \text{ V}, \text{ V}_{B} = 0.25 \text{ V}, \text{ R}_{L} = 1.0 \text{ k}\Omega)$ V_{OH} Vdc 4.9 _ _ Input Resistor R1 3.3 4.7 6.1 kΩ **Resistor Ratio** R_1/R_2 _ _

VOL

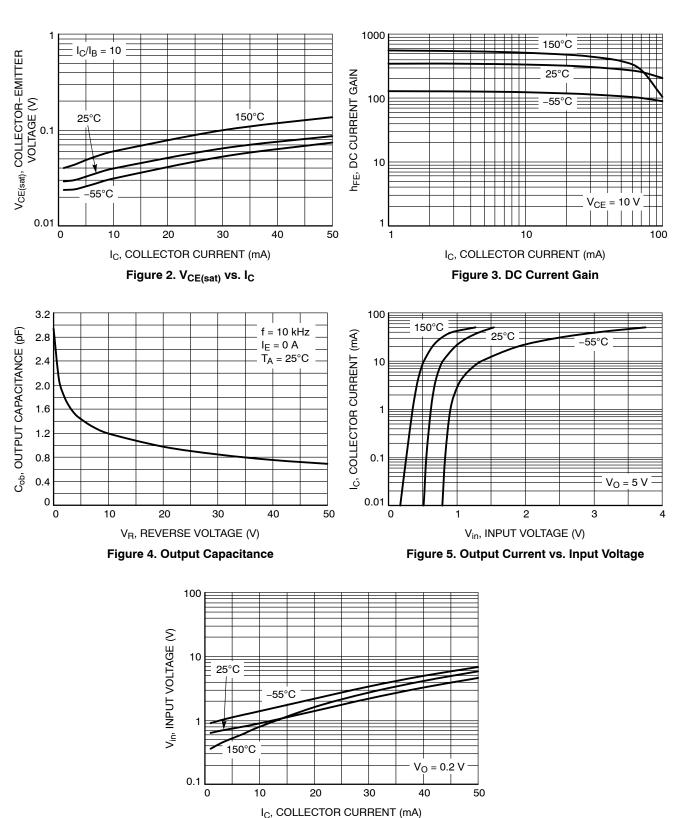
Vdc

0.2

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

6. Pulsed Condition: Pulse Width = 300 msec, Duty Cycle ≤ 2%.

MUN2216, MMUN2216L, MUN5216, DTC143TE, DTC143TM3, NSBC143TF3

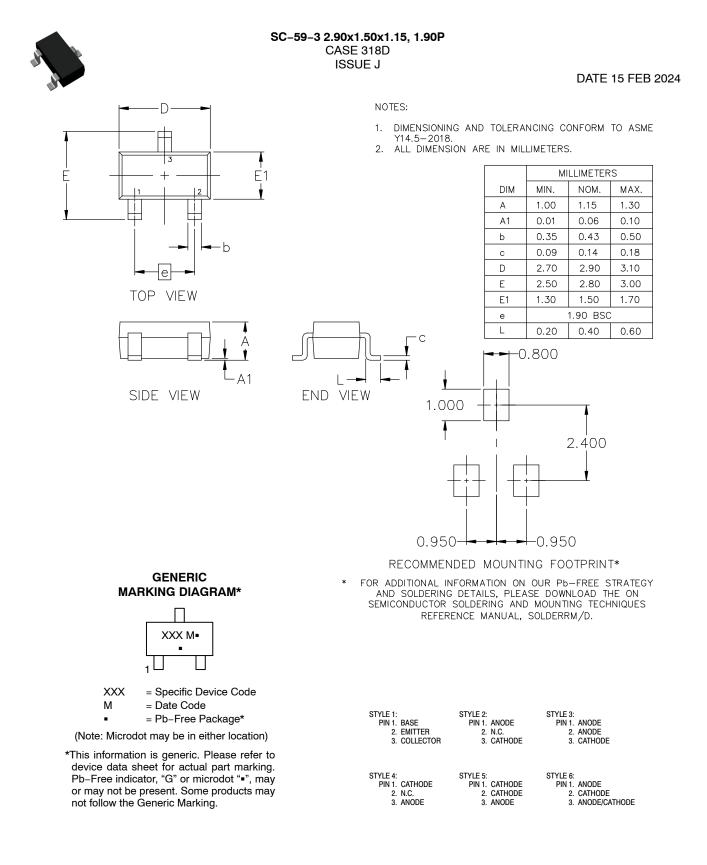


TYPICAL CHARACTERISTICS MUN2216, MMUN2216L, MUN5216, DTC143TE, DTC143TM3

Figure 6. Input Voltage vs. Output Current

MUN2216, MMUN2216L, MUN5216, DTC143TE, DTC143TM3, NSBC143TF3

PACKAGE DIMENSIONS



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SOT-23 (TO-236) 2.90x1.30x1.00 1.90P **CASE 318**

ISSUE AU

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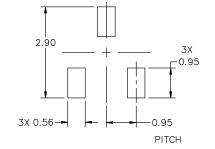




XXX = Specific Device Code М = Date Code

= Pb-Free Package .

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.



MILLIMETERS					
DIM	MIN	NOM	МАХ		
А	0.89	1.00	1.11		
A1	0.01	0.06	0.10		
b	0.37	0.44	0.50		
с	0.08	0.14	0.20		
D	2.80	2.90	3.04		
E	1.20	1.30	1.40		
е	1.78	1.90	2.04		
L	0.30	0.43	0.55		
L1	0.35	0.54	0.69		
Ηe	2.10	2.40	2.64		
Т	0°		10°		

NOTES:

DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 2018. CONTROLLING DIMENSIONS: 1.

2. MILLIMETERS.

MILLIME IERS. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF THE 3.

BASE MATERIAL. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH, 4. PROTRUSIONS, OR GATE BURRS.

RECOMMENDED MOUNTING FOOTPRINT

* For additional information on our Pb-Free strategy and soldering details, please download the onsemi Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

STYLES ON PAGE 2

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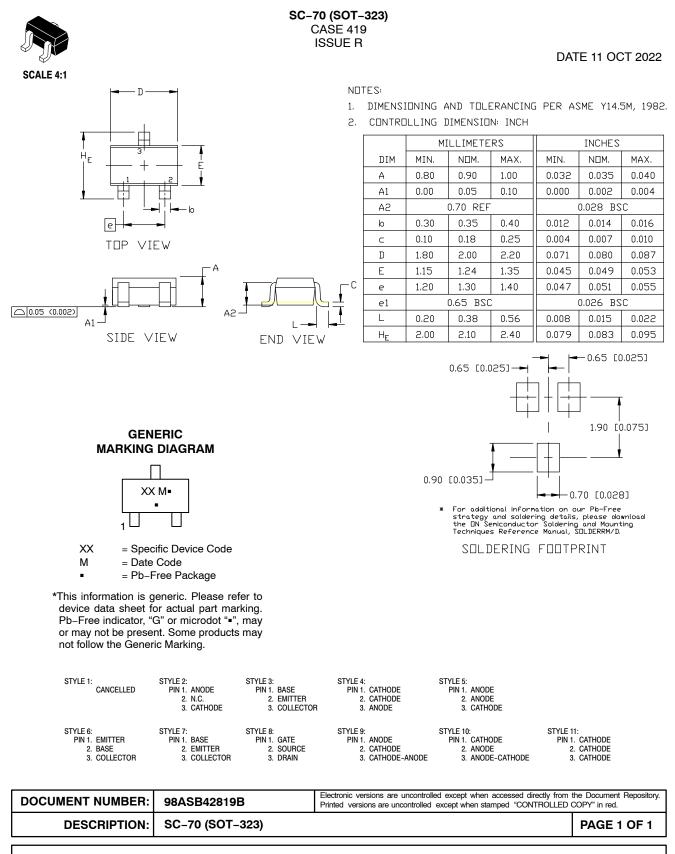
DATE 14 AUG 2024

STYLE 1 THRU 5: CANCELLED	STYLE 6: PIN 1. BASE 2. EMITTER 3. COLLECTOR	STYLE 7: PIN 1. EMITTER 2. BASE 3. COLLECTOR	STYLE 8: PIN 1. ANODE 2. NO CONNECTION 3. CATHODE	ı	
STYLE 9:	STYLE 10:	STYLE 11:	STYLE 12:	STYLE 13:	STYLE 14:
PIN 1. ANODE	PIN 1. DRAIN	PIN 1. ANODE	PIN 1. CATHODE	PIN 1. SOURCE	PIN 1. CATHODE
2. ANODE	2. SOURCE	2. CATHODE	2. CATHODE	2. DRAIN	2. GATE
3. CATHODE	3. GATE	3. CATHODE-ANODE	3. ANODE	3. GATE	3. ANODE
STYLE 15:	STYLE 16:	STYLE 17:	STYLE 18:	STYLE 19:	STYLE 20:
PIN 1. GATE	PIN 1. ANODE	PIN 1. NO CONNECTION	PIN 1. NO CONNECTION	I PIN 1. CATHODE	PIN 1. CATHODE
2. CATHODE	2. CATHODE	2. ANODE	2. CATHODE	2. ANODE	2. ANODE
3. ANODE	3. CATHODE	3. CATHODE	3. ANODE	3. CATHODE-ANODE	3. GATE
STYLE 21:	STYLE 22:	STYLE 23:	STYLE 24:	STYLE 25:	STYLE 26:
PIN 1. GATE	PIN 1. RETURN	PIN 1. ANODE	PIN 1. GATE	PIN 1. ANODE	PIN 1. CATHODE
2. SOURCE	2. OUTPUT	2. ANODE	2. DRAIN	2. CATHODE	2. ANODE
3. DRAIN	3. INPUT	3. CATHODE	3. SOURCE	3. GATE	3. NO CONNECTION
STYLE 27: PIN 1. CATHODE 2. CATHODE 3. CATHODE	STYLE 28: PIN 1. ANODE 2. ANODE 3. ANODE				

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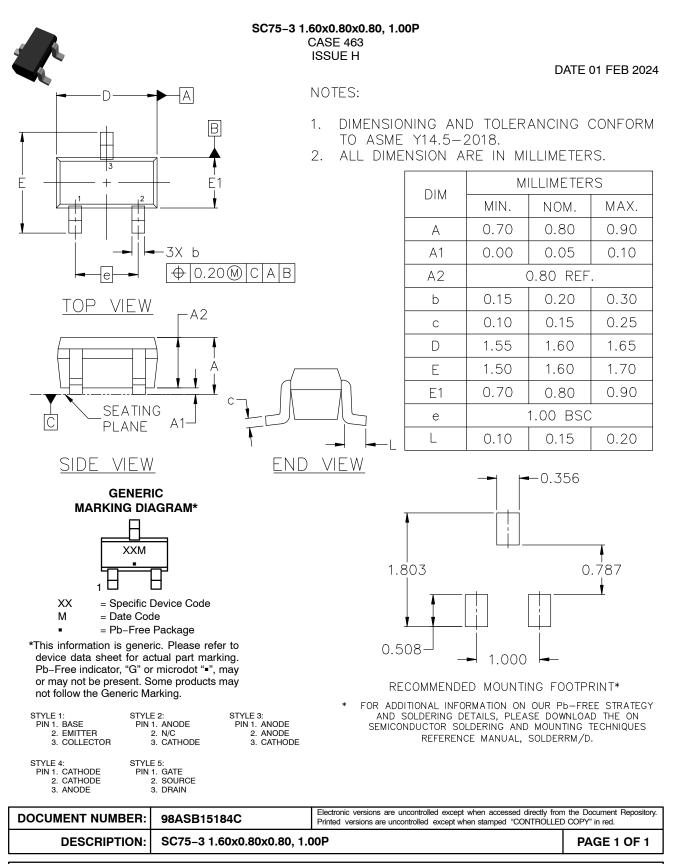
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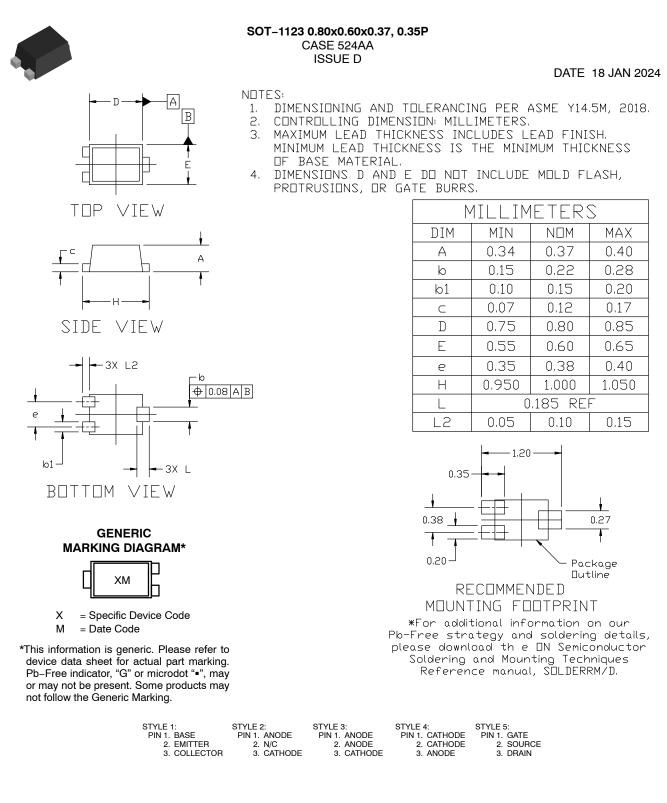
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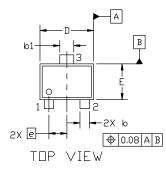


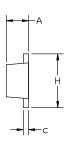
SOT-723 1.20x0.80x0.50, 0.40P CASE 631AA ISSUE E

DATE 24 JAN 2024

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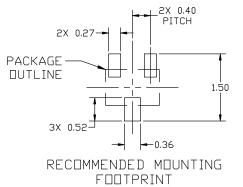
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- DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH, 4. PROTRUSIONS OR GATE BURRS.



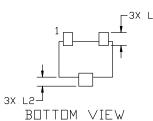


SIDE VIEW

		MILLIMETERS				
	DIM	MIN.	NDM.	MAX.		
1	А	0.45	0.50	0.55		
	b	0.15	0.21	0.27		
	b1	0.25	0.31	0.37		
	С	0.07	0.12	0.17		
	D	1.15	1.20	1.25		
	E	0.75	0.80	0.85		
	e		0.40 BSC			
	Н	1.15	1.20	1.25		
	L		0.29 REF	-		
	L2	0.15	0.20	0.25		



*For additional information on our Pb-Free strategy and soldering details, please download the DN Semiconductor Soldering and Mounting Techniques Reference Manual, SDLDERRM/D.



GENERIC **MARKING DIAGRAM***



XX = Specific Device Code = Date Code Μ

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

PIN 1. BASE PIN 2. EMITTER		2. ANODE 2	4: . CATHODE . CATHODE . ANODE	STYLE 5: PIN 1. GATE 2. SOURCE 3. DRAIN		
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